

## Advanced Power MOSFET

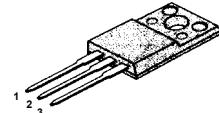
## IRLS540A

### FEATURES

- Logic Level Gate Drive
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : 10  $\mu$ A (Max.) @  $V_{DS} = 100V$
- Lower  $R_{DS(ON)}$  : 0.046 $\Omega$  (Typ.)

$BV_{DSS} = 100 V$   
 $R_{DS(on)} = 0.058 \Omega$   
 $I_D = 17 A$

TO-220F



1.Gate 2.Drain 3.Source

### Absolute Maximum Ratings

| Symbol         | Characteristic   | Value        | Units                |
|----------------|--|--------------|----------------------|
| $V_{DSS}$      | Drain-to-Source Voltage  | 100          | V                    |
| $I_D$          | Continuous Drain Current ( $T_C=25^\circ C$ )                            | 17           | A                    |
|                | Continuous Drain Current ( $T_C=100^\circ C$ )                           | 12           |                      |
| $I_{DM}$       | Drain Current-Pulsed ①   | 98           | A                    |
| $V_{GS}$       | Gate-to-Source Voltage   | $\pm 20$     | V                    |
| $E_{AS}$       | Single Pulsed Avalanche Energy ②   | 385          | mJ                   |
| $I_{AR}$       | Avalanche Current ①  | 17           | A                    |
| $E_{AR}$       | Repetitive Avalanche Energy ①  | 4.4          | mJ                   |
| $dv/dt$        | Peak Diode Recovery $dv/dt$ ③  | 6.5          | V/ns                 |
| $P_D$          | Total Power Dissipation ( $T_C=25^\circ C$ )                             | 44           | W                    |
|                | Linear Derating Factor   | 0.29         | $W/\text{ }^\circ C$ |
| $T_J, T_{STG}$ | Operating Junction and Storage Temperature Range                         | - 55 to +175 | $^\circ C$           |
|                | Maximum Lead Temp. for Soldering Purposes, 1/8 " from case for 5-seconds | 300          |                      |

### Thermal Resistance

| Symbol          | Characteristic      | Typ. | Max. | Units        |
|-----------------|---------------------|------|------|--------------|
| $R_{\text{JC}}$ | Junction-to-Case    | --   | 3.4  | $^\circ C/W$ |
| $R_{\text{JA}}$ | Junction-to-Ambient | --   | 62.5 |              |

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## Electrical Characteristics ( $T_C=25^\circ\text{C}$ unless otherwise specified)

| Symbol                 | Characteristic                          | Min. | Typ. | Max.  | Units                     | Test Condition  |
|------------------------|---|------|------|-------|---------------------------|---|
| $BV_{DSS}$             | Drain-Source Breakdown Voltage          | 100  | --   | --    | V                         | $V_{GS}=0\text{V}, I_D=250\mu\text{A}$  |
| $\Delta BV/\Delta T_J$ | Breakdown Voltage Temp. Coeff.          | --   | 0.1  | --    | $\text{V}/^\circ\text{C}$ | $I_D=250\mu\text{A}$ See Fig 7  |
| $V_{GS(\text{th})}$    | Gate Threshold Voltage                  | 1.0  | --   | 2.0   | V                         | $V_{DS}=5\text{V}, I_D=250\mu\text{A}$  |
| $I_{GSS}$              | Gate-Source Leakage , Forward           | --   | --   | 100   | nA                        | $V_{GS}=20\text{V}$   |
|                        | Gate-Source Leakage , Reverse           | --   | --   | -100  |                           | $V_{GS}=-20\text{V}$  |
| $I_{DSS}$              | Drain-to-Source Leakage Current         | --   | --   | 10    | $\mu\text{A}$             | $V_{DS}=100\text{V}$  |
|                        |   | --   | --   | 100   |                           | $V_{DS}=80\text{V}, T_C=150^\circ\text{C}$                                      |
| $R_{DS(\text{on})}$    | Static Drain-Source On-State Resistance | --   | --   | 0.058 | $\Omega$                  | $V_{GS}=5\text{V}, I_D=8.5\text{A}$ ④   |
| $g_f$                  | Forward Transconductance                | --   | 20.2 | --    | $\text{S}$                | $V_{DS}=40\text{V}, I_D=8.5\text{A}$ ④  |
| $C_{iss}$              | Input Capacitance                       | --   | 1215 | 1580  | pF                        | $V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$<br>See Fig 5               |
| $C_{oss}$              | Output Capacitance                      | --   | 310  | 390   |                           |   |
| $C_{rss}$              | Reverse Transfer Capacitance            | --   | 145  | 180   |                           |   |
| $t_{d(on)}$            | Turn-On Delay Time                      | --   | 7    | 25    | ns                        | $V_{DD}=50\text{V}, I_D=28\text{A}, R_G=4.6\Omega$<br>See Fig 13 ④ ⑤            |
| $t_r$                  | Rise Time                               | --   | 12   | 35    |                           |   |
| $t_{d(off)}$           | Turn-Off Delay Time                     | --   | 38   | 85    |                           |   |
| $t_f$                  | Fall Time                               | --   | 24   | 60    |                           |   |
| $Q_g$                  | Total Gate Charge                       | --   | 38.4 | 54    | nC                        | $V_{DS}=80\text{V}, V_{GS}=5\text{V}, I_D=28\text{A}$<br>See Fig 6 & Fig 12 ④ ⑤ |
| $Q_{gs}$               | Gate-Source Charge                      | --   | 6.2  | --    |                           |   |
| $Q_{gd}$               | Gate-Drain( "Miller" ) Charge           | --   | 23.3 | --    |                           |   |

## Source-Drain Diode Ratings and Characteristics

| Symbol   | Characteristic            | Min. | Typ. | Max. | Units         | Test Condition  |
|----------|---------------------------|------|------|------|---------------|---|
| $I_s$    | Continuous Source Current | --   | --   | 17   | A             | Integral reverse pn-diode in the MOSFET                                       |
| $I_{SM}$ | Pulsed-Source Current ①   | --   | --   | 98   |               |   |
| $V_{SD}$ | Diode Forward Voltage ④   | --   | --   | 1.5  | V             | $T_J=25^\circ\text{C}, I_S=17\text{A}, V_{GS}=0\text{V}$                      |
| $t_{rr}$ | Reverse Recovery Time     | --   | 132  | --   | ns            | $T_J=25^\circ\text{C}, I_F=28\text{A}$<br>$dI_F/dt=100\text{A}/\mu\text{s}$ ④ |
| $Q_{rr}$ | Reverse Recovery Charge   | --   | 0.63 | --   | $\mu\text{C}$ |   |

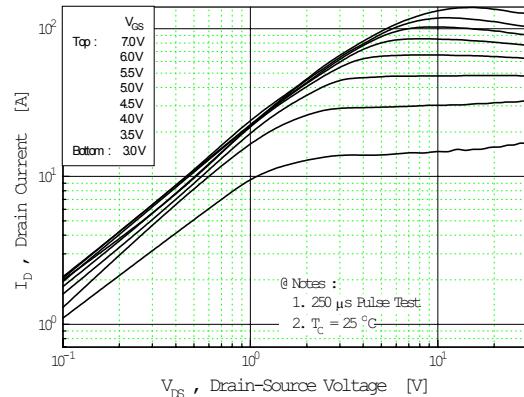
### Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ②  $L=2\text{mH}, I_{AS}=17\text{A}, V_{DD}=25\text{V}, R_G=27\Omega$ , Starting  $T_J=25^\circ\text{C}$
- ③  $I_{SD}\leq 28\text{A}, di/dt\leq 400\text{A}/\mu\text{s}, V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width =  $250\mu\text{s}$ , Duty Cycle  $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

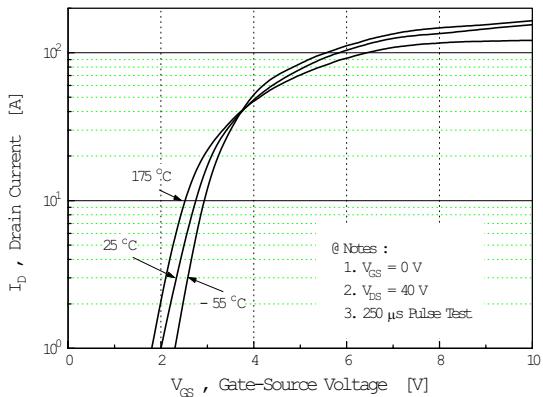
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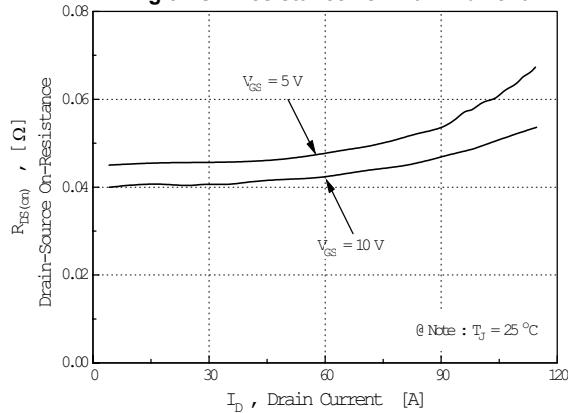
**Fig 1. Output Characteristics**



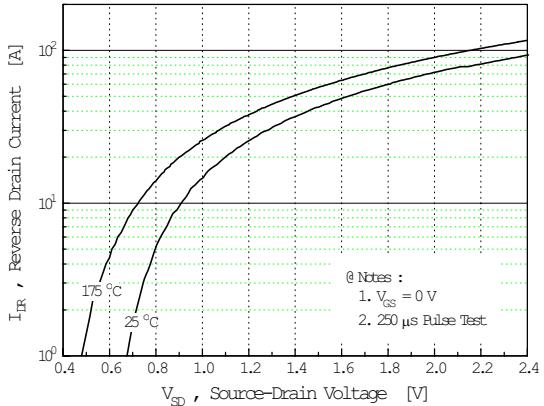
**Fig 2. Transfer Characteristics**



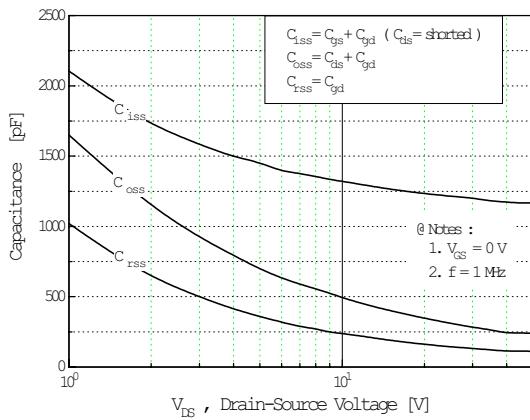
**Fig 3. On-Resistance vs. Drain Current**



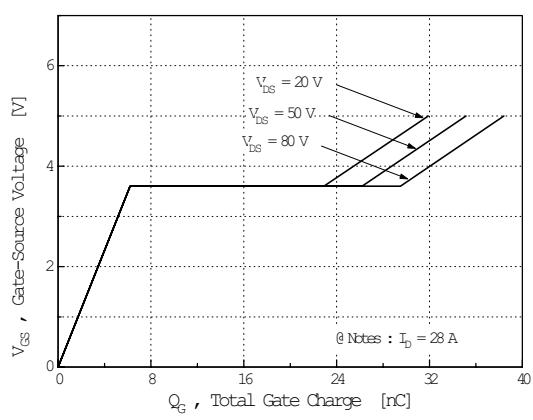
**Fig 4. Source-Drain Diode Forward Voltage**



**Fig 5. Capacitance vs. Drain-Source Voltage**

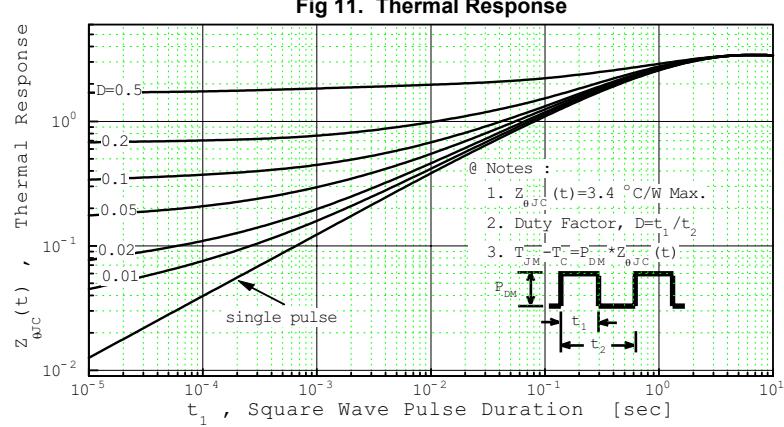
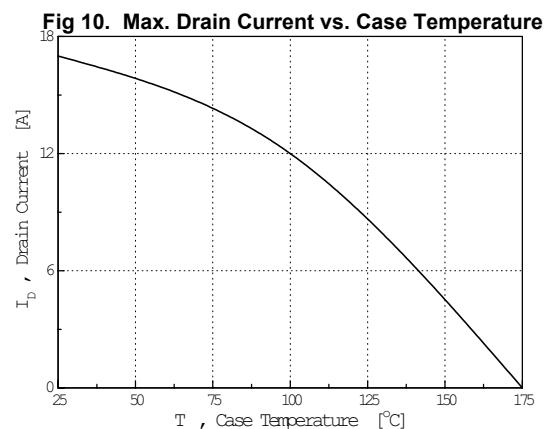
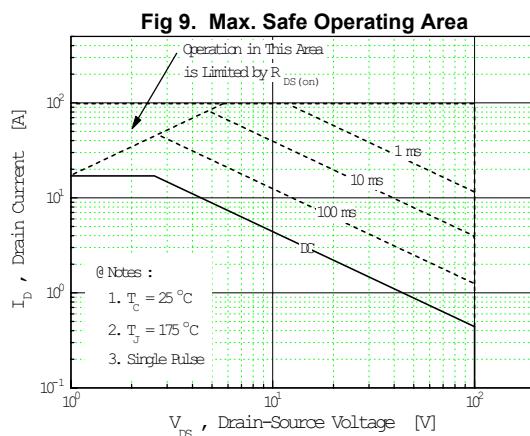
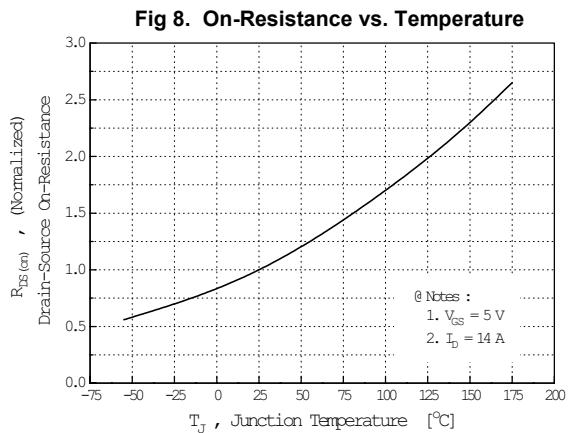
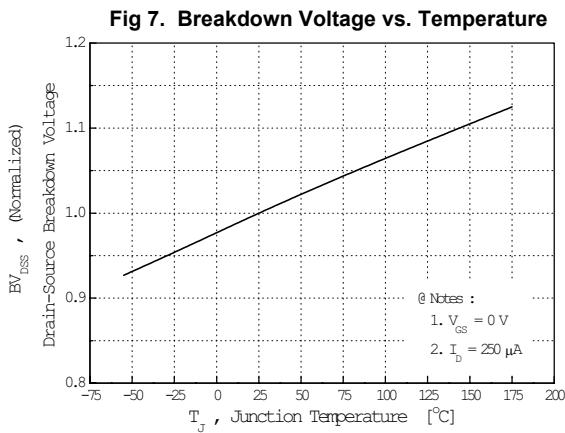


**Fig 6. Gate Charge vs. Gate-Source Voltage**

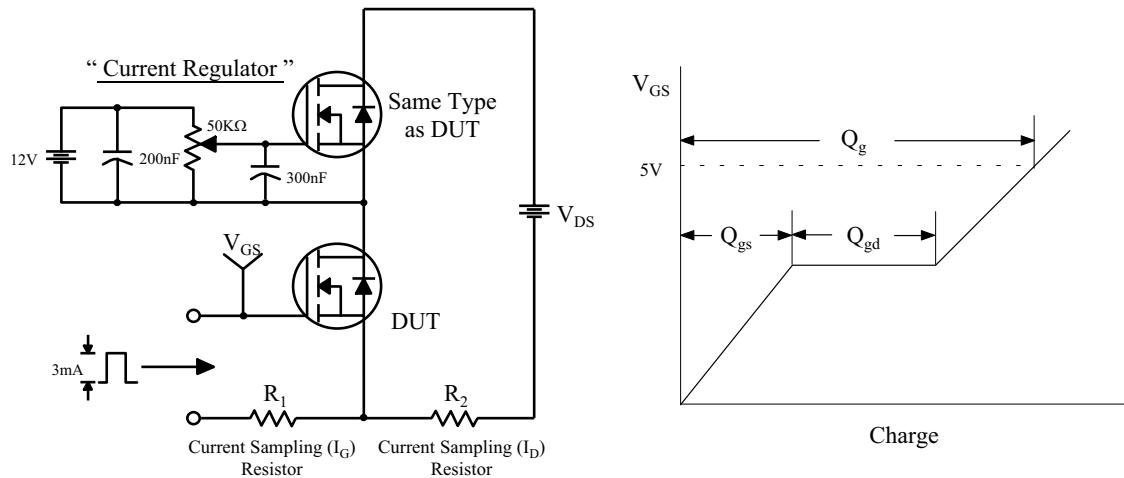


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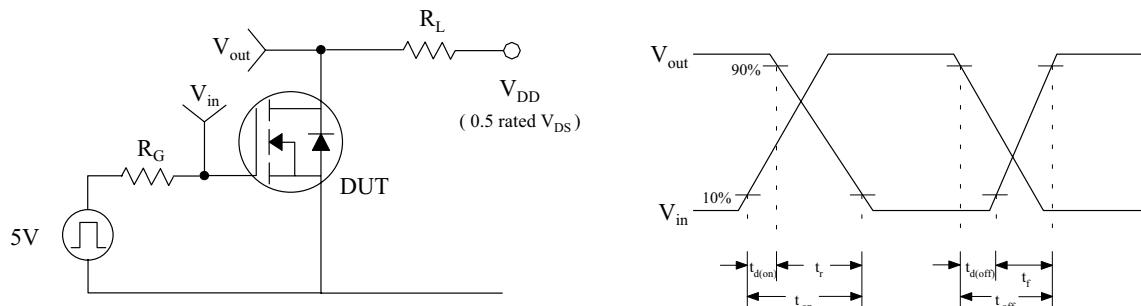
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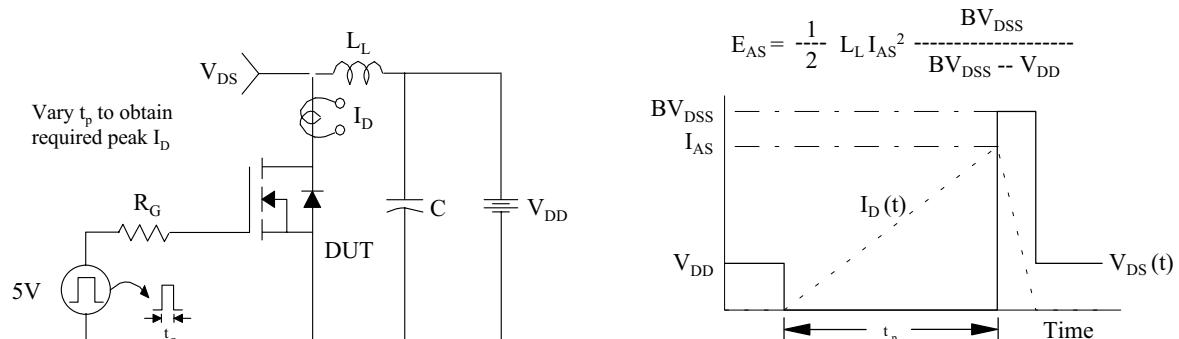
**Fig 12. Gate Charge Test Circuit & Waveform**



**Fig 13. Resistive Switching Test Circuit & Waveforms**



**Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms**



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Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

